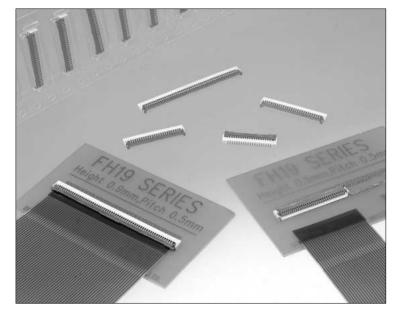
World's smallest & lightest

0.5mm pitch, 0.9mm above the board, Flexible Printed Circuit & Flexible Flat Cable Connectors

FH19 & FH19S Series



Features

World's smallest & lightest

1. Low-profile 0.5mm pitch FPC, FFC Connectors

Miniaturization of portable equipment and personal mobile devices has created increased demand for a low profile, high density, and high reliability connectors.

*The design of this connector has been made thinner and smaller, with a height of 0.9mm and width of 3mm.

[As of August 2002, this is the smallest connector of this type available on the market !]

*PCB footprint: Reduced approximately 48% (as compared with Hirose Electric's 0.5mm pitch FH12 Series connectors)

*Connector weight: Reduced approximately 78% (as compared with Hirose Electric's 0.5mm pitch FH12 Series connectors)

2. Conductive traces on the PCB can be designed to run under the connector

All bottom surface of the connector is solid, without any exposure of the contact.

3. Proven Flip-Lock Actuator System assures easy and reliable operation

Rotating actuator permits easy insertion and reliable connection with the FPC & FFC.

Tactile sensation confirms complete mechanical locking of the actuator and the electrical connection.

4. Accepts 0.2mm & 0.3mm thick FPC, FFC

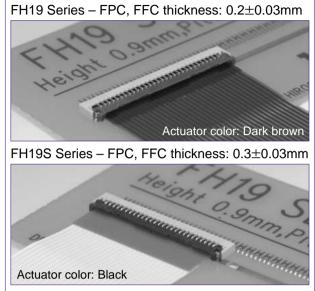
Accepts 0.2mm & 0.3mm thick FPC, FFC, easy inserted in the connector.

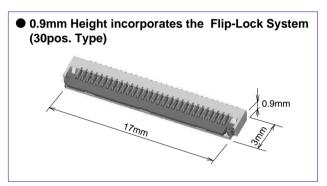
The connector will also terminate successfully with 0.2mm thick Flat Flexible Cable (FFC).

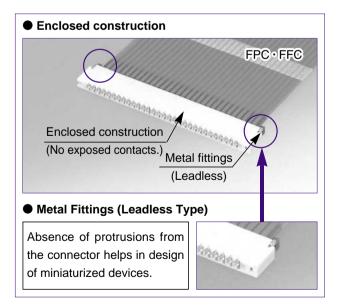
5. Designed for placement with automatic equipment Packaged in embossed tape, on reel. One reel contains 5,000 pieces.

6. Environmental considerations

Plating is lead-free. In addition, the center cores of the embossed tape reels are made of paper, unlike typical cores made of styrofoam.







Applications

Notebook PC's, PDA's, digital cameras and other compact devices requiring interconnections of the main circuit board with the LCD, plasma display (PDP), HDD or other devices.



Product Specifications

Rating	Current rating 0.5 A DC	Operating temperature range -55℃ to +80℃ (Note 1) Operating humidity range	Storage temperature range -10°C to +50°C (Note 2) Storage humidity range	
	Voltage rating 50 V AC	Relative humidity 90% max. (No condensation)	Relative humidity 90% max.	
Recommended	FH19 Series	Thickness: = 0.2 ± 0.03 mm tinned copper or pure tin plating (Note 3)		

FPC, FFCFH19S SeriesThickness: = 0.3 ± 0.03 mm tinned copper or pure tin plating (Note 3)

Item	Specification	Conditions
1. Insulation resistance	500 M ohms min.	100 V DC
2. Withstanding voltage	No flashover or insulation breakdown	150 V AC/1 minute
3. Contact resistance	100 m ohms max. *Including FPC/FFC conductor resistance	1 mA
4. Durability (insertion/ withdrawal)	Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	20 cycles
5. Vibration	No electrical discontinuity of 1 μ s or more. Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours in each of the 3 directions
6. Shock	No electrical discontinuity of 1 μ s. min. Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	Acceleration of 981 m/s ² , 6 ms duration, sine half- wave waveform, 3 cycles in each of the 3 axis.
7. Humidity (Steady state)	Contact resistance: 100 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation.	96 hours at temperature of 40°C and humidity of 90 to 95%
8. Temperature cycle	Contact resistance: 100 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation.	Temperature: $-40^{\circ}C \rightarrow +15^{\circ}C$ to $+35^{\circ}C \rightarrow +85^{\circ}C \rightarrow +15^{\circ}C$ to $+35^{\circ}C$ Time: $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to 3 (Minutes) 5 cycles
9. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C±5°C for 5 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

Note 3: When FPC is gold plated, the connector contacts should be also gold plated: Select the (05) specification.

Materials

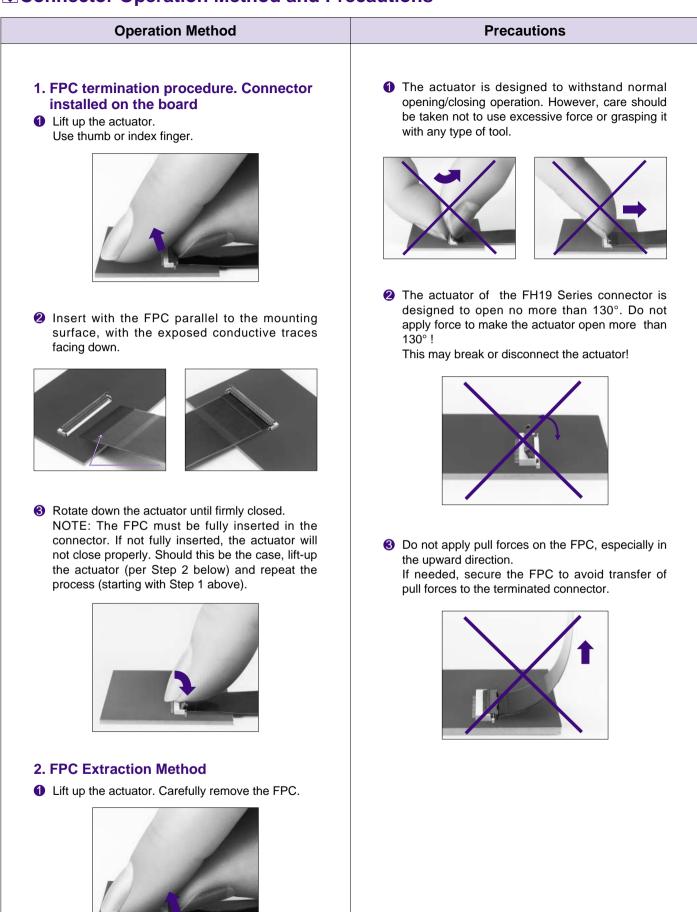
Part	Material	Finish	Remarks
	LCP	Color: Beige	
Insulator	PPS	Color: Dark brown (FH19 Series) Color: Black (FH19S Series)	UL94V-0
Contacts	Phosphor bronze	Pure tin plating (Note 3)	
Metal fittings	Phosphor bronze	Pure tin reflow plating	

Ordering information

$\frac{\mathsf{FH19}}{\bullet} \quad \frac{\mathsf{S}}{\bullet} \quad \frac{\mathsf{30S}}{\bullet} \quad \frac{\mathsf{0.5}}{\bullet} \quad \frac{\mathsf{SH}}{\bullet} \quad \frac{\mathsf{(05)}}{\bullet}$

Series name :	FH19	Contact pitch : 0.5mm
2 Blank : S :	FPC,FFC thickness : 0.2mm FPC,FFC thickness : 0.3mm	Terminal type SH: SMT horizontal mounting type
3 No. of contacts :	4,9,13,17,20,27,30,(40,50)	Plating specifications : Blank: Pure tin plating (05): Gold plating

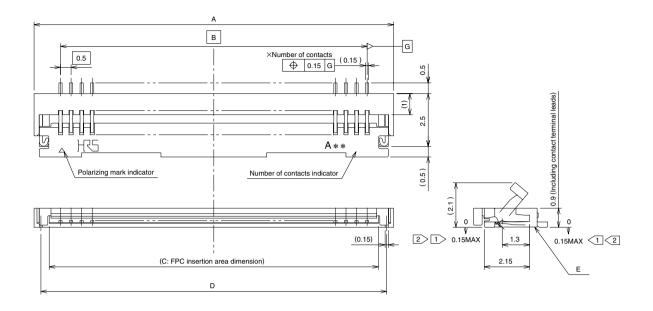
Connector Operation Method and Precautions



40 **HS**

Connector Dimension

[FH19 Series]



Notes $\boxed{1}$ The coplanarity of each terminal lead and metal fitting is within 0.1

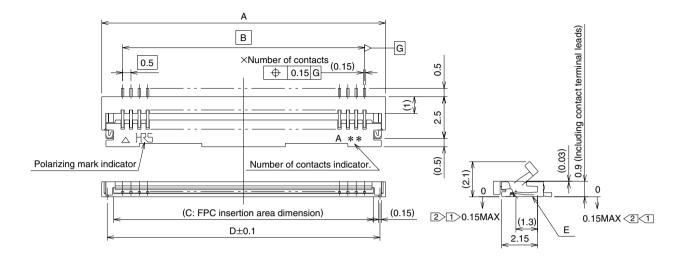
- $\overline{|2\rangle}$ The contact terminal lead position indicates the dimension from the E surface, the bottom surface of the insulator body.
- 3 The connector is supplied in embossed tape packaging. For details see the Packaging Specifications Diagram on Page 6.
- 4 Any discoloration of the plastic compound will NOT AFFECT form, fit or function of the connector.

						Unit: mm
Part Number	CL No.	Number of Contacts	А	В	С	D
FH19-4S-0.5SH	586-1009-8	4	4.0	1.5	2.57	3.35
FH19-9S-0.5SH	586-1006-0	9	6.5	4.0	5.07	5.85
FH19-13S-0.5SH	586-1001-6	13	8.5	6.0	7.07	7.85
FH19-17S-0.5SH	586-1007-2	17	10.5	8.0	9.07	9.85
FH19-20S-0.5SH	586-1002-9	20	12.0	9.5	10.57	11.35
FH19-24S-0.5SH	586-1011-0	24	14.0	11.5	12.57	13.35
FH19-27S-0.5SH	586-1000-3	27	15.5	13.0	14.07	14.85
FH19-30S-0.5SH	586-1003-1	30	17.0	14.5	15.57	16.35
FH19-40S-0.5SH	Reserved for product expansion	40	22.0	19.5	20.57	21.35
FH19-50S-0.5SH	Reserved for product expansion	50	27.0	24.5	25.57	26.35

Note: Embossed tape reel packaging (5,000 pieces/reel) .

Order by number of reels.

[FH19S Series]



Notes 1 The coplanarity of each terminal lead and metal fitting is within 0.1

- $|2\rangle$ The contact terminal lead position indicates the dimension from the E surface, the bottom surface of the insulator body.
- 3 The connector is supplied in embossed tape packaging. For details see the Packaging Specifications Diagram on Page 6.
- 4 Any discoloration of the plastic compound will NOT AFFECT form, fit or function of the connector.

						Unit: mm
Part Number	CL No.	Number of Contacts	А	В	С	D
FH19S-12S-0.5SH	586-1105-1	12	8.0	5.5	6.57	7.35
FH19S-17S-0.5SH	586-1100-8	17	10.5	8.0	9.07	9.85
FH19S-18S-0.5SH	Reserved for product expansion	18	11.0	8.5	9.57	10.35
FH19S-20S-0.5SH	586-1101-0	20	12.0	9.5	10.57	11.35
FH19S-22S-0.5SH	Reserved for product expansion	22	13.0	10.5	11.57	12.35
FH19S-24S-0.5SH	586-1102-3	24	14.0	11.5	12.57	13.35
FH19S-26S-0.5SH	586-1104-9	26	15.0	12.5	13.57	14.35
FH19S-27S-0.5SH	586-1103-6	27	15.5	13.0	14.07	14.85
FH19S-50S-0.5SH	Reserved for product expansion	50	27.0	24.5	25.57	26.35

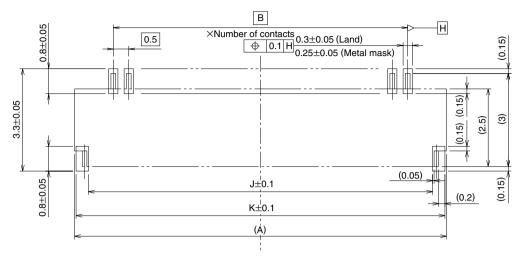
Note: Embossed tape reel packaging (5,000 pieces/reel) .

Order by number of reels.

Recommended PCB Land and Metal Mask Dimensions

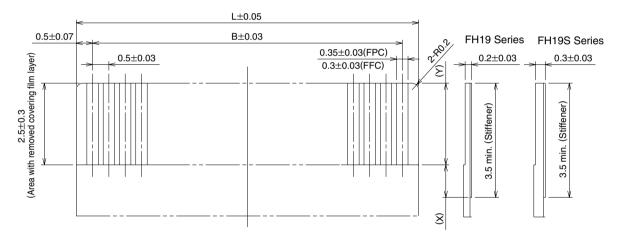
[Common to FH19 & FH19S Series]

Recommended metal mask thickness: 0.10 mm.



Recommended FPC, FFC Dimensions

[Common to FH19 & FH19S Series]



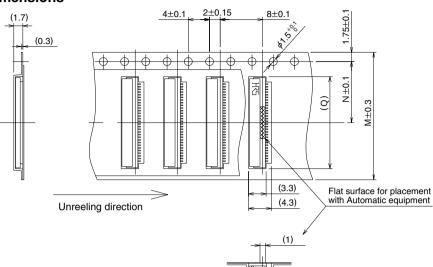
Note1: Polyamide and a thermally hardened adhesive is recommended as the materials for the stiffener. Note2: Y dimension should be 1.5mm min., and X dimension should be 0.5mm for improved flexibility of FPC.

					Unit: mm
Number of Contacts	А	В	J	К	L
4	4.0	1.5	3.1	3.9	2.5
9	6.5	4.0	5.6	6.4	5.0
12	8.0	5.5	7.1	7.9	6.5
13	8.5	6.0	7.6	8.4	7.0
17	10.5	8.0	9.6	10.4	9.0
18	11.0	8.5	10.4	10.9	9.5
20	12.0	9.5	11.1	11.9	10.5
22	13.0	10.5	12.1	12.9	11.5
24	14.0	11.5	13.1	13.9	12.5
26	15.0	12.5	14.1	14.9	13.5
27	15.5	13.0	14.6	15.4	14.0
30	17.0	14.5	16.1	16.9	15.5
40	22.0	19.5	21.1	21.9	20.5
50	27.0	24.5	26.1	26.9	25.5

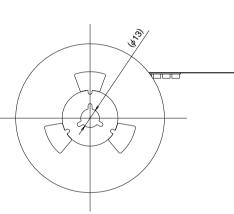
Packaging Specifications

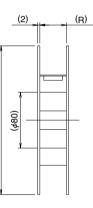
[Common to FH19 & FH19S Series]

• Embossed Carrier Tape Dimensions

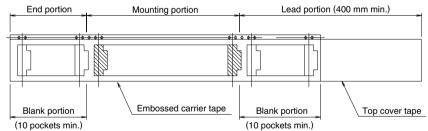


Reel Dimensions





(¢380)



				Unit: mm
Number of Contacts	М	N	Q	R
4	16	7.5	4.3	16.5
9	16	7.5	6.8	16.5
12	16	7.5	8.3	16.5
13	16	7.5	8.8	16.5
17	24	11.5	10.8	24.5
18	24	11.5	11.3	24.5
20	24	11.5	12.3	24.5
22	24	11.5	13.3	24.5
24	24	11.5	14.3	24.5
26	24	11.5	15.3	24.5
27	24	11.5	15.8	24.5
30	24	11.5	17.3	24.5
40	44	20.2	22.3	44.5
50	44	20.2	27.3	44.5

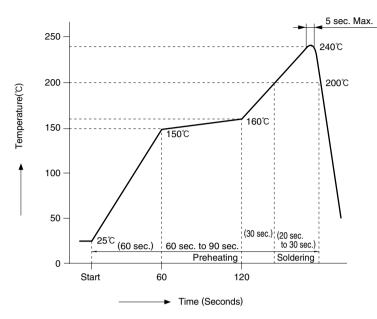
Notes: 5,000 pieces per reel.

Embossed tape 32 mm or wider will have perforated feed holes on two sides.

Recommended Temperature Profile

[Common to FH19 & FH19S Series]

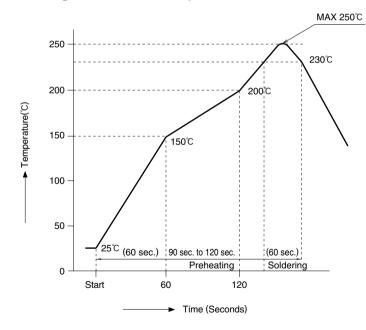




Applicable conditions	
Reflow method	: IR reflow
Solder	: Paste type 63 Sn/37 Pb
	(Flux content 11/wt%)
Test board	: Glass epoxy 45 mm x 100 mm x 1.6 mm
Metal mask thickness	: 0.1 mm

Recommended temperature profile. The temperature may be slightly changed according to the solder paste type and amount.

Using Lead-free Solder paste



Applicable Conditions	
Reflow method	: IR reflow
Solder	: Paste type Sn/3.0Ag/0.5Cu
	(Flux content 11 wt%)
Test board	: Glass epoxy 45 x 100 x 1.6 mm
Metal mask thickness	: 0.1 mm

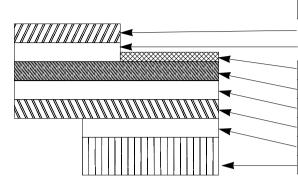
Recommended temperature profile. The temperature may be slightly changed according to the solder paste type and amount.



●FH19 & FH19S Series FPC/FFC Construction (Recommended Specifications)

1. Using Single-sided FPC

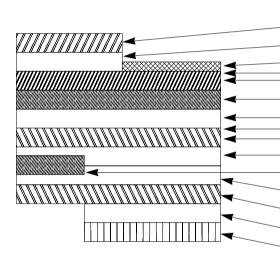




Material Name		Material		ss (µm)
	I			FH19S
- Covering film layer.	Polyamide	1 mil thick	25	25
- Cover adhesive			25	25
Surface treatment	Tinned copper p	Tinned copper plating or pure tin plating		5
Copper foil	Cu	1oz	35	35
Base adhesive			25	25
Base film	Polyamide	1 mil thick	25	25
Reinforcement material adhesive	Heat-harden	ed adhesive	30	30
Stiffener	Polyamide	3 mil thick	75	175
	Total		195	295

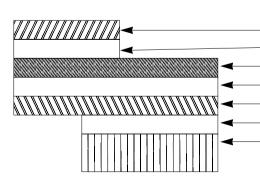
2. Dual-sided FPC

FPC : Flexible Printed Circuit



Material Name	Material		Thickness (µm)	
Material Name	r	vialenai	FH19	FH19S
Covering layer film	Polyamide	1 mil thick	25	
Cover adhesive			25	
Surface treatment	Tinned copper p	plating or pure tin plating	5	5
Through-hole copper	Cu		15	15
Copper foil	Cu	1/2oz	18	18
Base adhesive			18	18
Base film	Polyamide	1 mil thick	25	25
Base adhesive			18	18
Copper foil	Cu	1/2oz	18	18
Cover adhesive			25	25
Covering layer film	Polyamide	1 mil thick	25	25
Reinforcement material adhesive	Heat-harden	ed adhesive	25	50
Stiffener	Polyamide	1 mil thick	25	100
	Total		199	299

3. Using FFC (Flexible Flat Cable)



FFC : Flexible Flat Cable

Material Name		Material	Thickness (µm)	
			FH19	FH19S
Polyester film			12	12
— Adhesive		Polyester thermoplastic type	30	30
Tin plated, soft copper film			35	35
Adhesive		Polyester	30	30
Polyester			12	12
Adhesive		Polyester	30	30
Stiffener		Polyester	100	188
		Total	207	295

* Practical tolerance of thickness dimension is $\pm 20 \mu m$ (i.e., 187 to $227 \mu m$).

Note 1: The 0.2mm thick FFC is the 0.3mm thick FFC with different stiffener.

Note 2: This specification is a recommendation for the FH19, FH19S Series connectors using FPC/FFC 0.2/0.3 ±0.03mm thick.